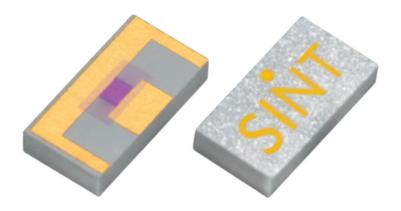
High Frequency Surface Mountable Chip Terminations

SMT CHIP TERMINATION, DC-67 GHZ



Smiths Interconnect's High Frequency SMT Chip Terminations series is designed to offer excellent broadband performance up to 67GHz, providing optimized return loss across the frequency band.

The patented layout provides substantial power handling in a small lightweight package, up to 1 Watt CW of input power, thanks to the added thermal paths this product provides.

Several qualification tests have been completed to ensure long term reliability in critical applications, including thermal shock, burn, RF over temperature, low temperature operation, high temperature exposure, peak power, and solder mount integrity. The results have confirmed that CTX SMT design and RF performance are ideal to support RF and microwave applications in Defence, Space, Aerospace and 5G broadband demanding market segments.

The CTX SMT series of chip terminations offer a unique combination of high power and high frequency in a small package

Features and Benefits

- Frequency rating DC to 67 GHz with optimized return loss
- VSWR performance 1.25:1 Typical (1.50:1 Maximum)
- Power rating up to 1 Watts CW in a small 0603 package
- Qualification testing per MIL-PRF-55342
- Total thin film technology offering tighter mechanical tolerances for better control of the RF performance.
- Environmentally-friendly materials compliant to RoHS standards
- High volume production capability supporting customers' quick ramp up program needs

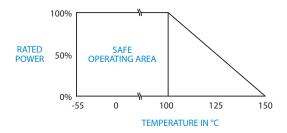
Applications

- Amplifier Circuits
- Isolators
- Transmit/Receive Modules
- Up/Down Converters
- Instrumentation
- Satellite Communications
- Radar

Technical Characteristics

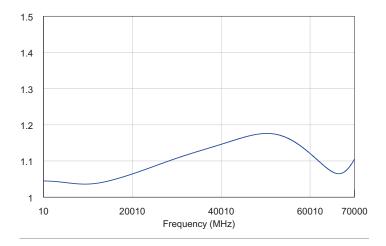
Mounting Configuration Options	CTH0603ALN1SMTF					
Electrical						
Nominal Impedance	50 ohms ± 10%					
Frequency Range	DC-67 GHz					
Input Power CW	1 Watt					
Peak Power	10X CW power based on 1 µS pulse width @ 1% Duty Cycle					
VSWR	1.25:1 Typical; 1.50:1 Max					
	Note: When properly matched in a 50 ohm system using Smiths Interconnect Suggested Mounting Guidelines.					
Environmental						
Operating Temperature	-55°C to +150°C					
Storage Temperature	-65°C to +150°C					
Temperature Coefficient	± 200 PPM/°C Max					
Moisture Sensitivity Level	MSL 1 - Unlimited					
Mechanical						
Substrate Material	Aluminum Nitride					
Resistive Film	Thin Film, Tantalum Nitride					
Terminal Material	Thin Film, Gold over Nickel					
Ground Bars	Thin Film, Gold over Nickel					
Protective Coating	Silicon Nitride					
Marking						
Unit Marking	SINT & Orientation Dot					
Quality Assurance						
	Sample visual and mechanical inspection - 1.0 AQL per mechanical drawing requirements.					
	Periodic electrical inspection performed for commerical grade products.					
	High reliability tested products are available per MIL-PRF-55342.					
Packaging						
Standard Packaging	Tape and Reel or Waffle Pack					

Power Derating Curve



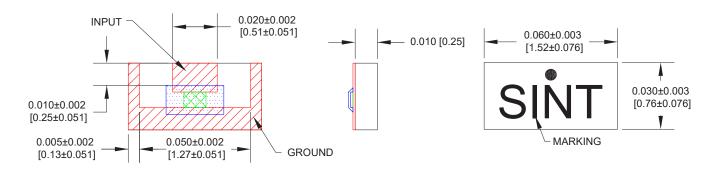
Typical Data

CTH0603ALN1SMTF Series VSWR

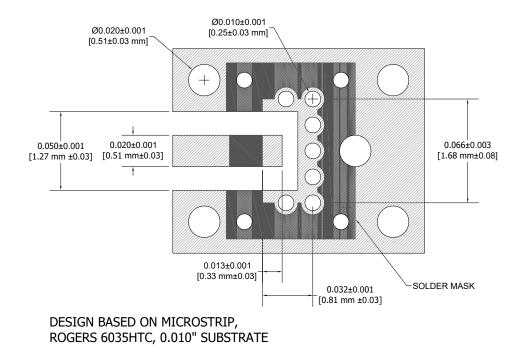


Mechanical

CTH0603ALN1SMTF - Surface Mountable



Suggested Mounting Footprint



How To Order

Specify Model Number: CTH 0603 ALN 1 SMT F

CTH	0 6 0 3	ALN	1	SMT	E	
1	2	3	4	5	6	
1 Model Name	C T H Chip Termination					
2 Dimensions	0 6 0 3 Length and Width (0.06" X .030")					
3 Substrate	A L N Aluminum Nitride					
4 Frequency	1 1 - DC-67 GHz					
5 Options	S M T Surface Mount					
6 Terminal Finish	F RoHS Compliant					

Global Support



Americas

- Kansas City, KS
 +1 913 342 5544
 info.us@smithsinterconnect.com
- Tampa, FL+ 1 813 901 7200info.tampa@smithsinterconnectinc.com
- Milpitas, CA
 +1 408 957 9607 x-1125
 info.us@smithsinterconnect.com
- Kirkland, QC, Canada
 +1 514 842 5179
 info.us@smithsinterconnect.com
- Salisbury, MD
 +1 800 780 2169
 info.us@smithsinterconnect.com

Europe

- Deggendorf, Germany +49 991 250 120 info.de@smithsinterconnect.com
- Rouen, France+33 2 3296 9176info.fr@smithsinterconnect.com
- Dundee, UK+44 1382 427 200info.dundee@smithsinterconnect.com
- Genova, Italy+39 0 10 60361info.it@smithsinterconnect.com

Asia

- Bangalore, India+91 080 4241 0529info.in@smithsinterconnect.com
- Singapore+65 6846 1655info.asia@smithsinterconnect.com
- Mianyang, China +86 816 231 5566 HSICSR@hf-smiths.com
- Suzhou, China+86 512 6273 1188info.asia@smithsinterconnect.com
- Shanghai, China+86 21 2283 8008info.asia@smithsinterconnect.com

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